

Test Laboratory: Compliance Certification Services  
File Name: [Ch 1013 - RC1 SO3 8k Enhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 824.7 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

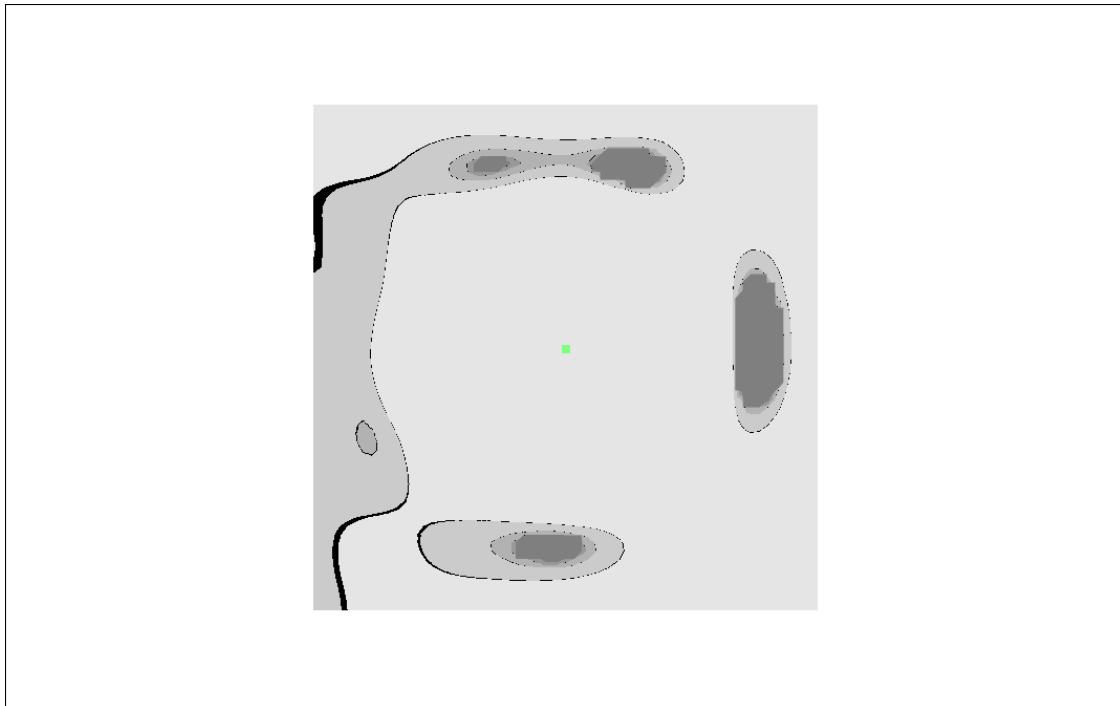
Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 47.4857 dB

BWC Factor = -0.206004 dB

Location: 0, -0.8, 363.7 mm



0 dB = 1.00

Test Laboratory: Compliance Certification Services  
File Name: [Ch 383 - RC1 SO3 8K Enhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 836.49 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

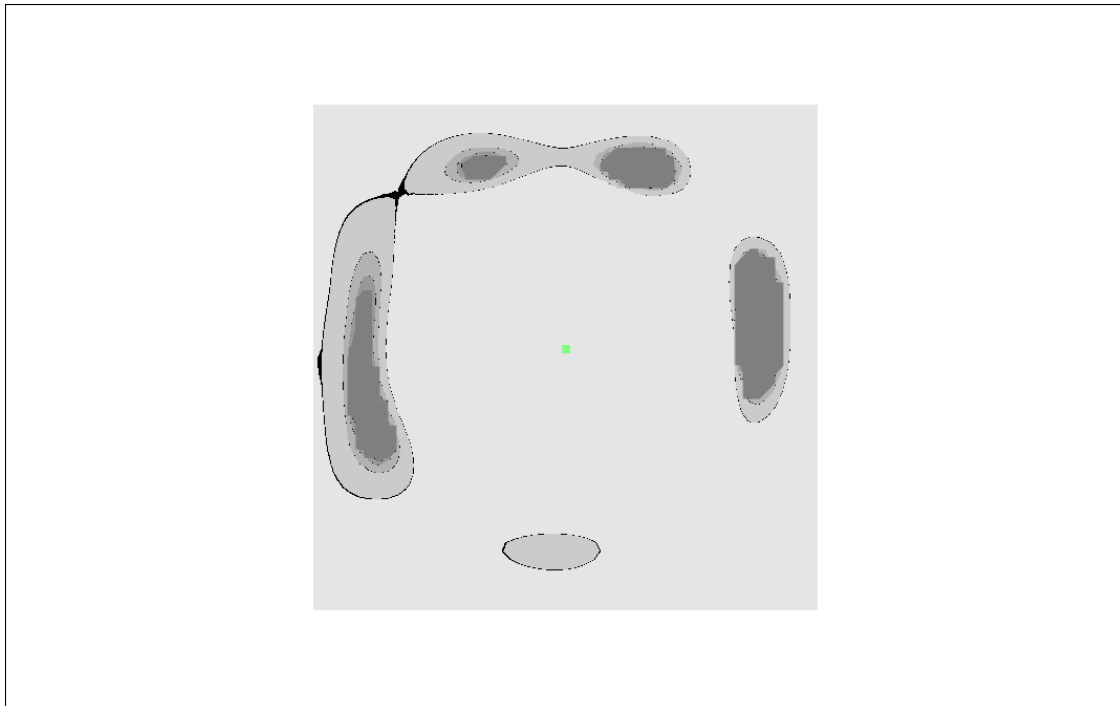
Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 45.4418 dB

BWC Factor = -0.206004 dB

Location: 0, -0.8, 363.7 mm



0 dB = 1.00

Test Laboratory: Compliance Certification Services  
File Name: [Ch 777- RC1 SO3 8k Enhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 848.31 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

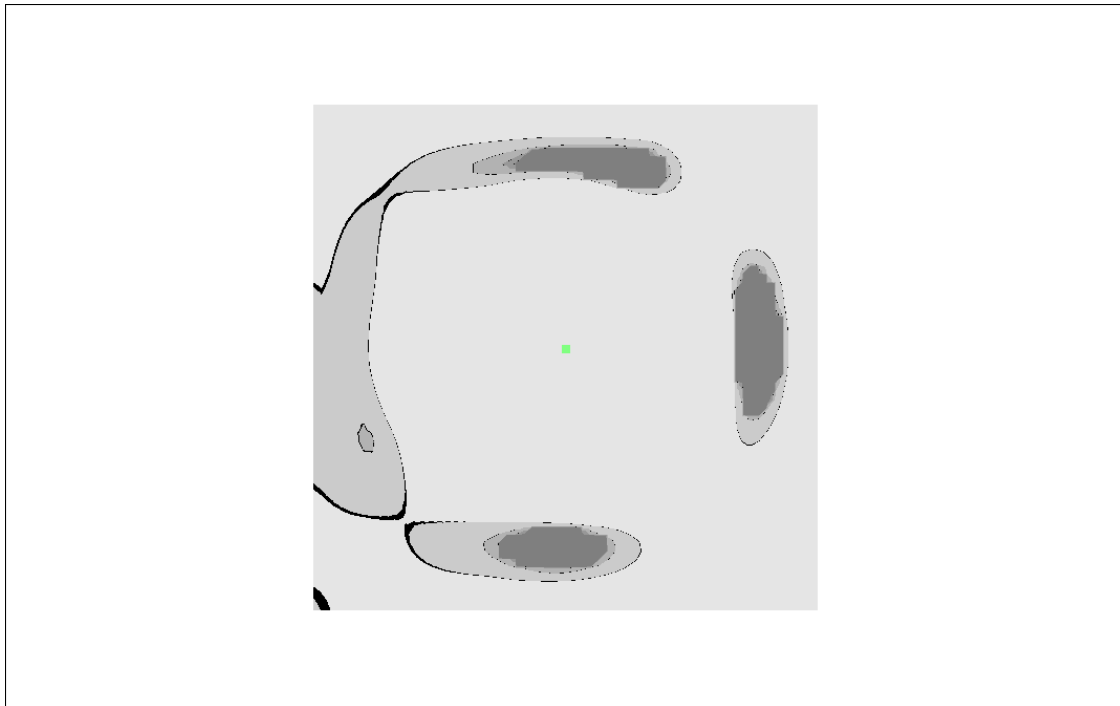
Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 48.1727 dB

BWC Factor = -0.206004 dB

Location: 0, -0.8, 363.7 mm



0 dB = 1.00

Test Laboratory: Compliance Certification Services  
File Name: [Ch 383 - RC3 SO3 8K Enhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 836.49 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

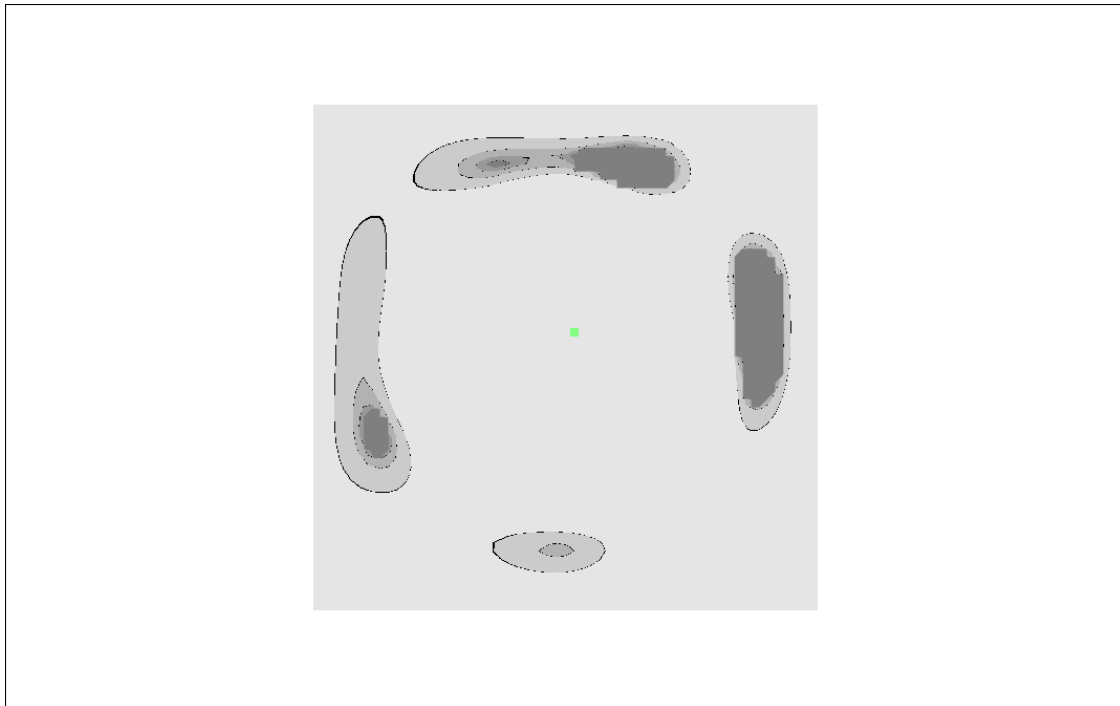
Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 46.6759 dB

BWC Factor = -0.204999 dB

Location: -0.8, -2.5, 363.7 mm



0 dB = 1.00

Test Laboratory: Compliance Certification Services  
File Name: [Ch 383 - RC43 SO3 8K Enhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 836.49 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

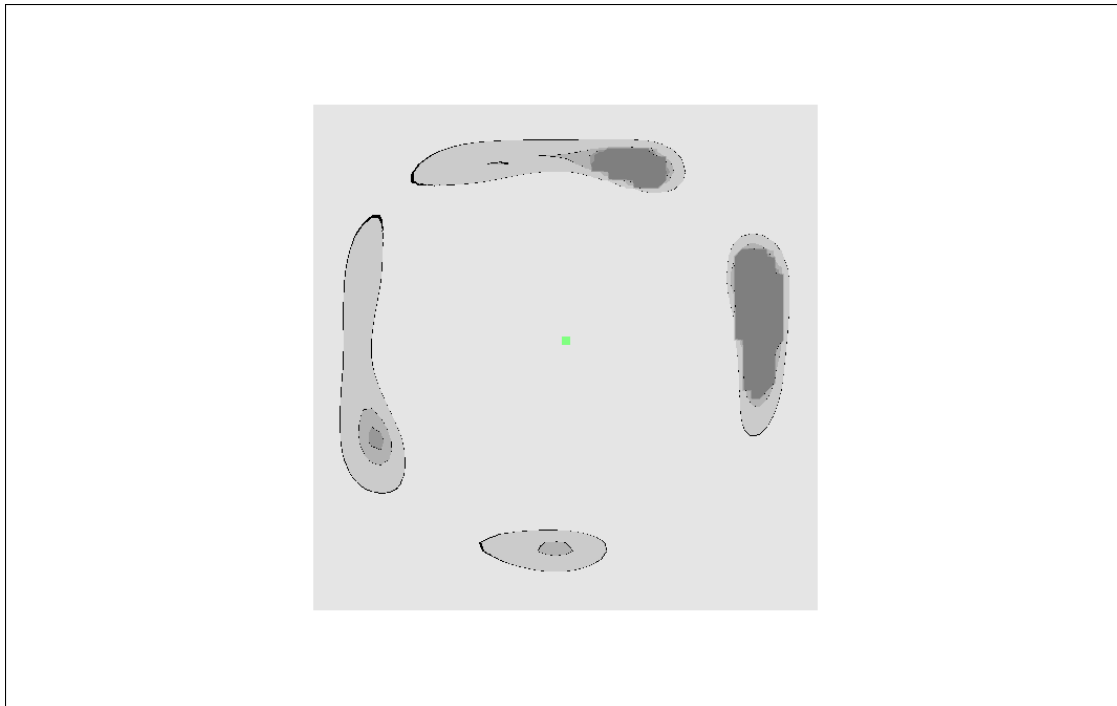
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 47.4227 dB  
BWC Factor = -0.206004 dB  
Location: 0, -1.7, 363.7 mm



0 dB = 1.00

Test Laboratory: Compliance Certification Services  
File Name: [Ch 600 - RC1 SO3 8k Enhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

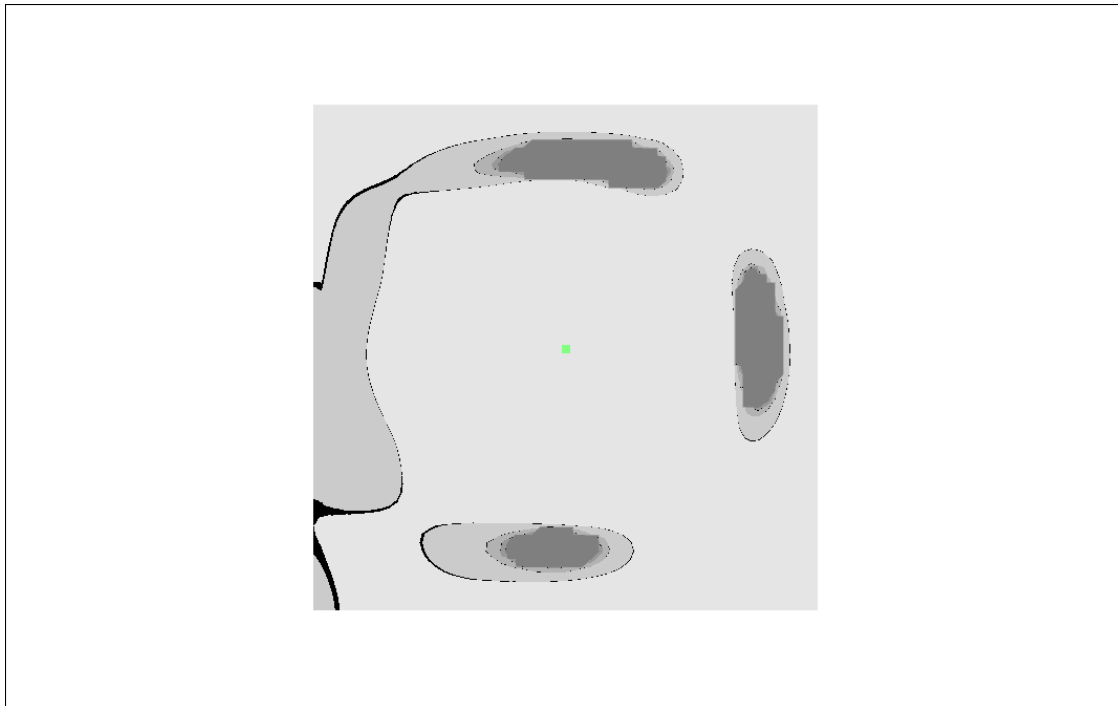
Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 49.1317 dB

BWC Factor = -0.206004 dB

Location: 0, -0.8, 363.7 mm



0 dB = 1.00

Test Laboratory: Compliance Certification Services  
File Name: [ch 25 RC3 SO3 8kEnhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 1851.25 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

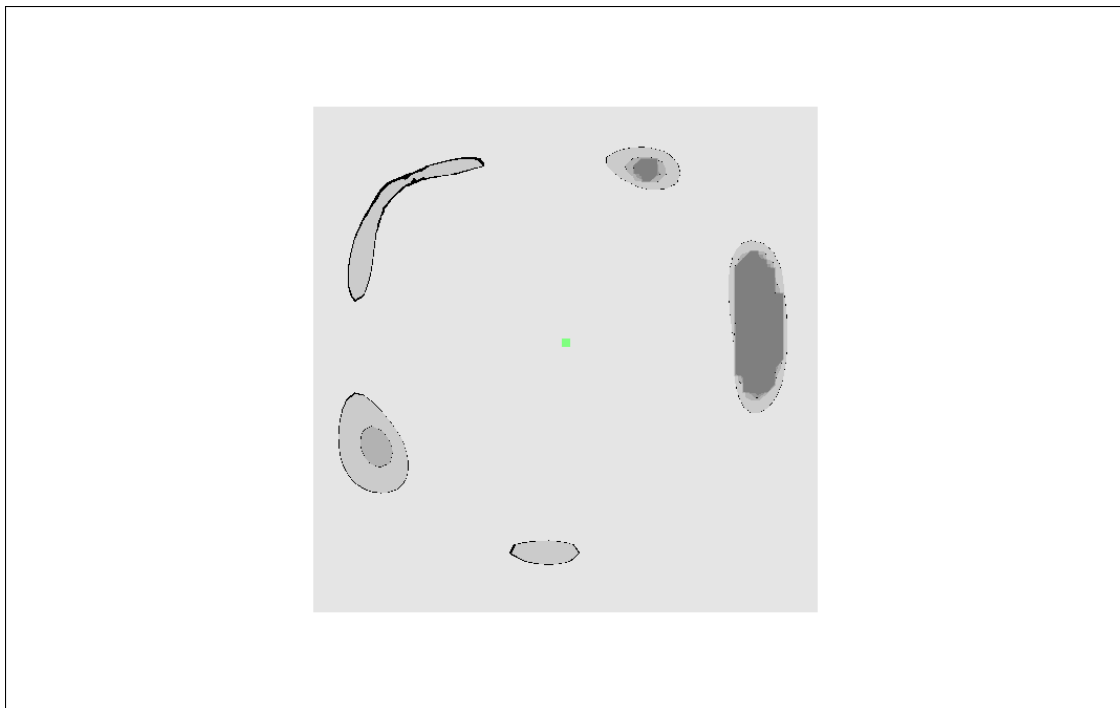
Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 47.8538 dB

BWC Factor = -0.204003 dB

Location: 0, -1.7, 363.7 mm



0 dB = 1.00

Test Laboratory: Compliance Certification Services  
File Name: [ch 600 RC3 SO3 8kEnhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

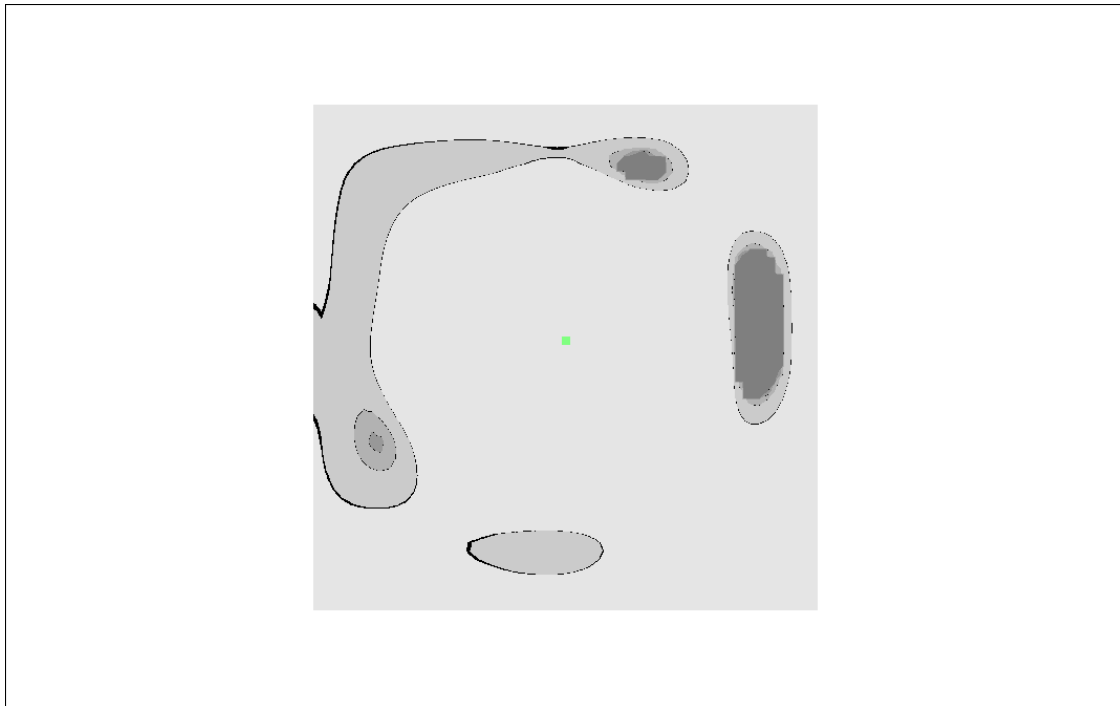
Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 46.5298 dB

BWC Factor = -0.204003 dB

Location: 0, -1.7, 363.7 mm



0 dB = 1.00



Test Laboratory: Compliance Certification Services  
File Name: [ch 1175 RC3 SO3 8kEnhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 1908.75 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

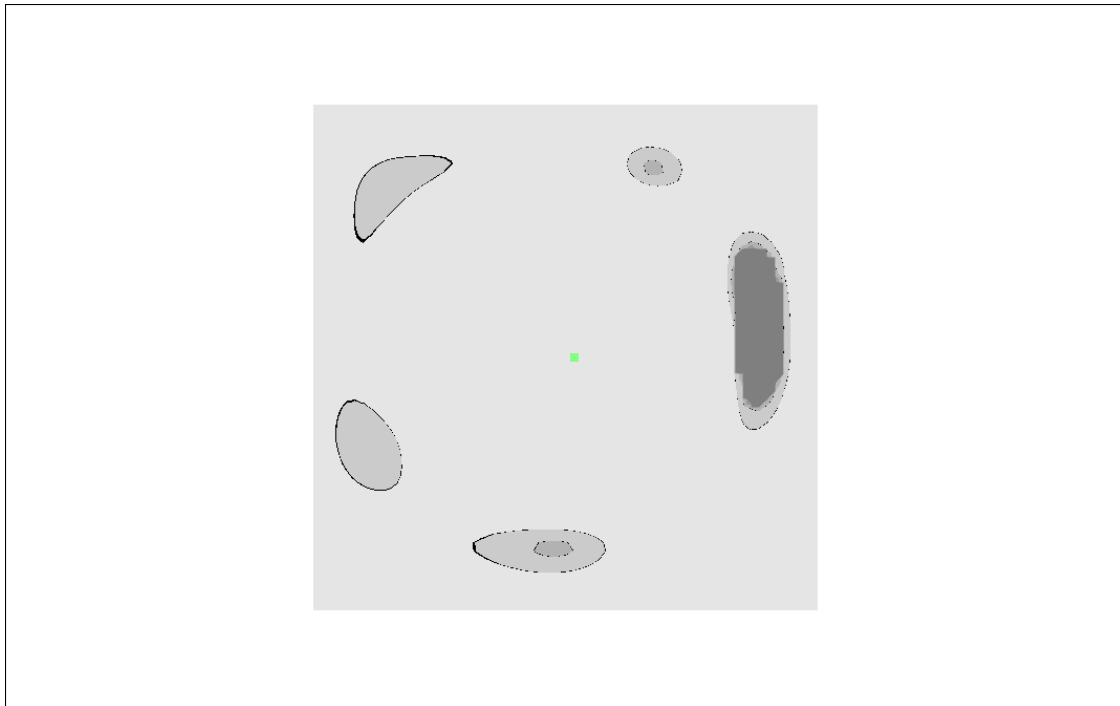
Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 48.0443 dB

BWC Factor = -0.204999 dB

Location: -0.8, 0, 363.7 mm



0 dB = 1.00

Test Laboratory: Compliance Certification Services  
File Name: [ch 600 RC43 SO3 8kEnhanced Low.da4](#)

**DUT: Kyocera; Type: K132; Serial: N/A**  
**Program Name: HAC\_TCoil\_WD\_Emission**

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1  
Medium parameters used:  $\sigma = 0$  mho/m,  $\epsilon_r = 1$ ;  $\rho = 1$  kg/m<sup>3</sup>  
Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

**Scans/z (axial) rough 50 x 50/ABM SNR Category(x,y,z) (61x61x1):**

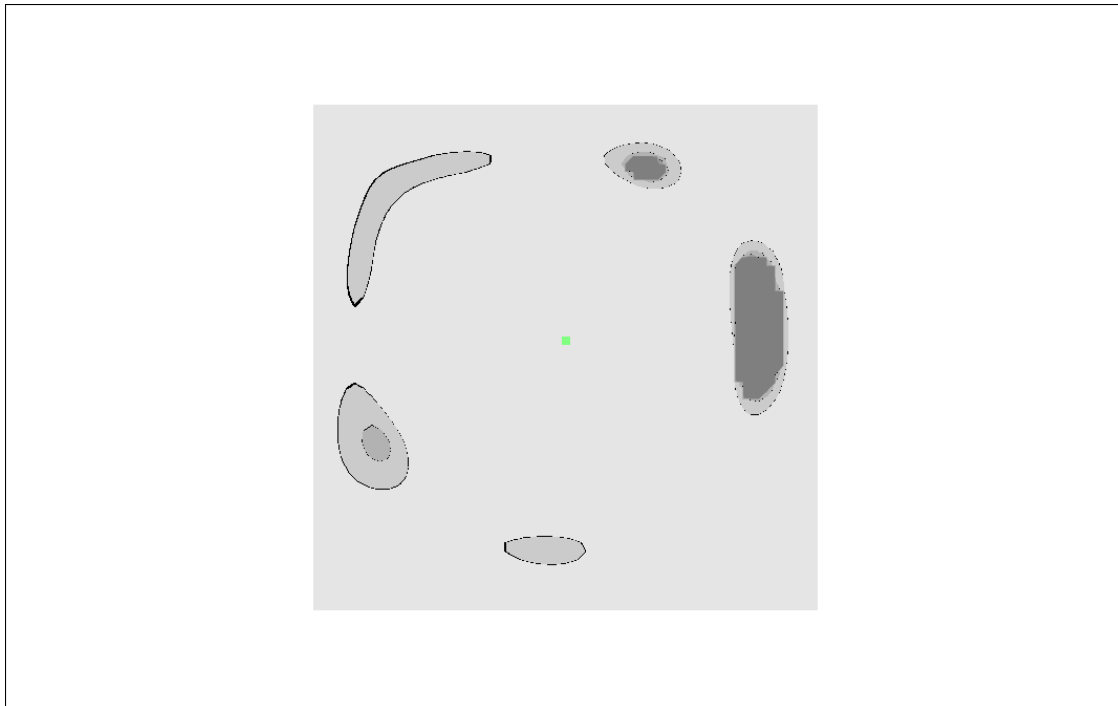
Measurement grid: dx=10mm, dy=10mm

**Cursor:**

ABM1/ABM2 = 47.9152 dB

BWC Factor = -0.204003 dB

Location: 0, -1.7, 363.7 mm



0 dB = 1.00